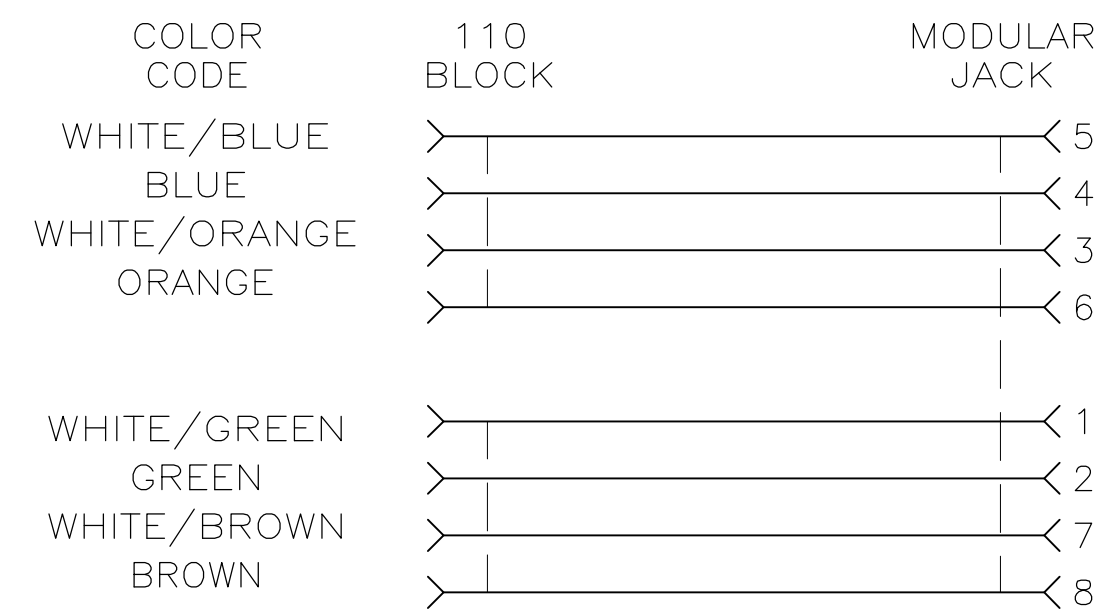
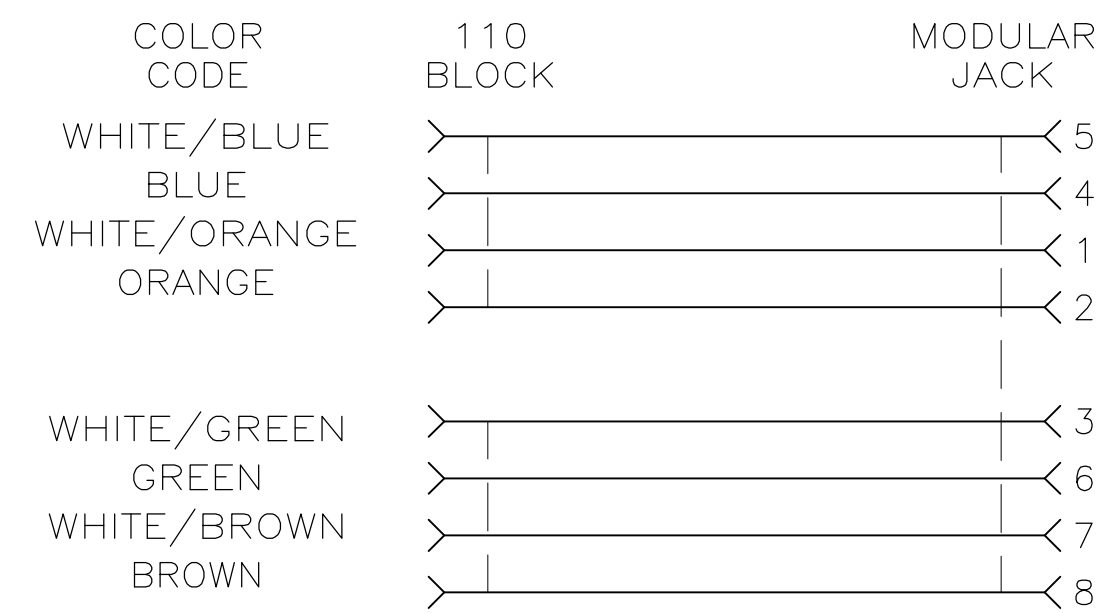
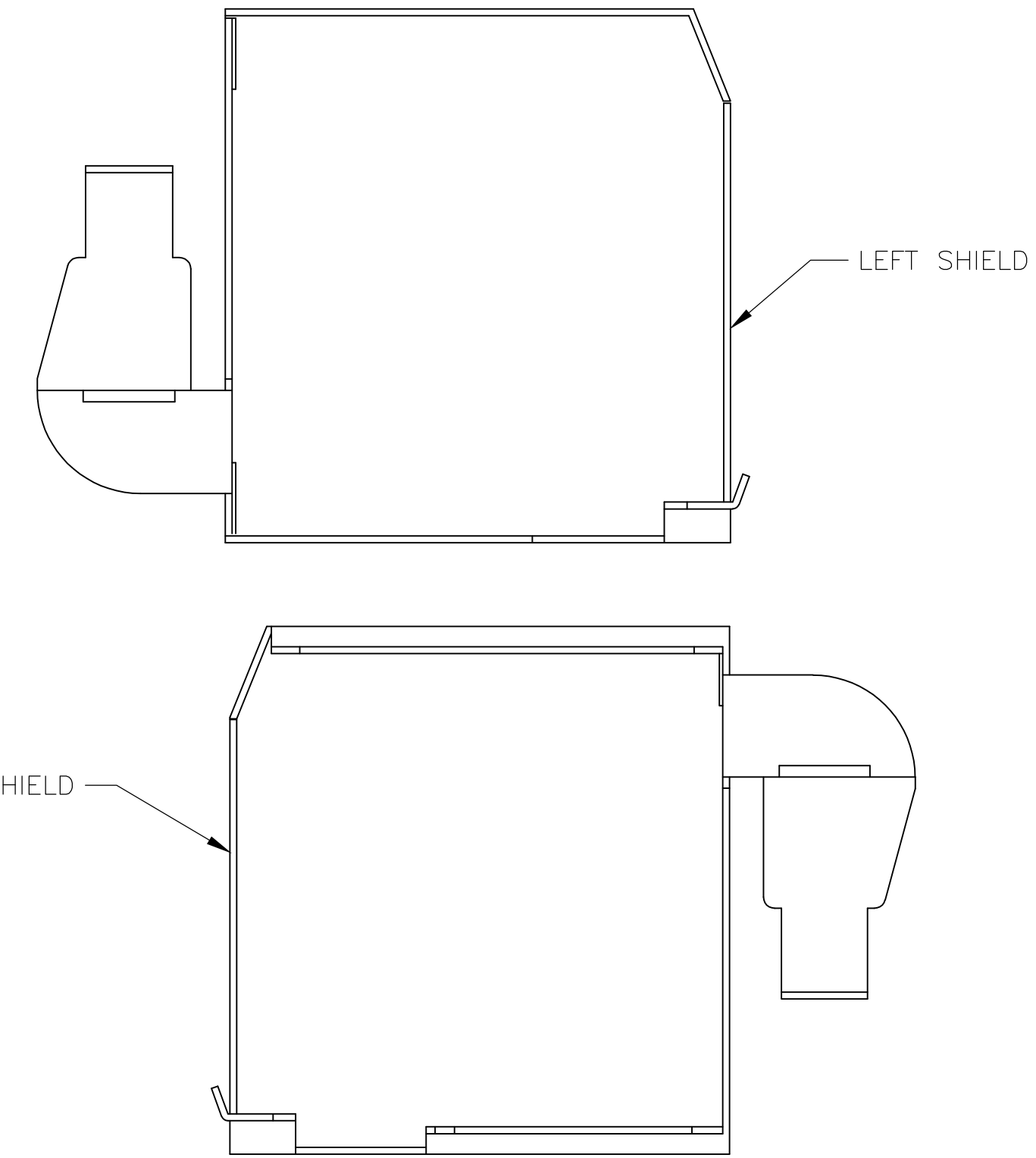


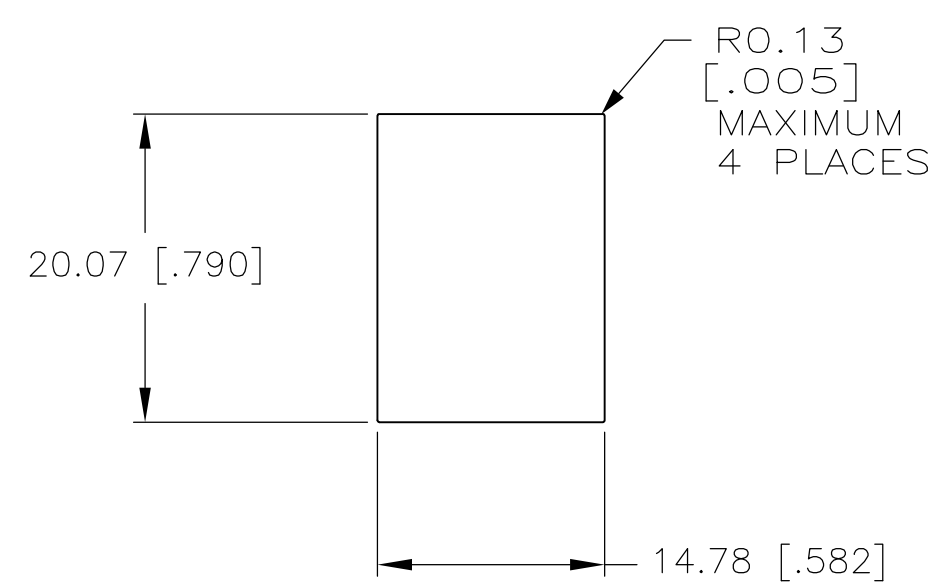
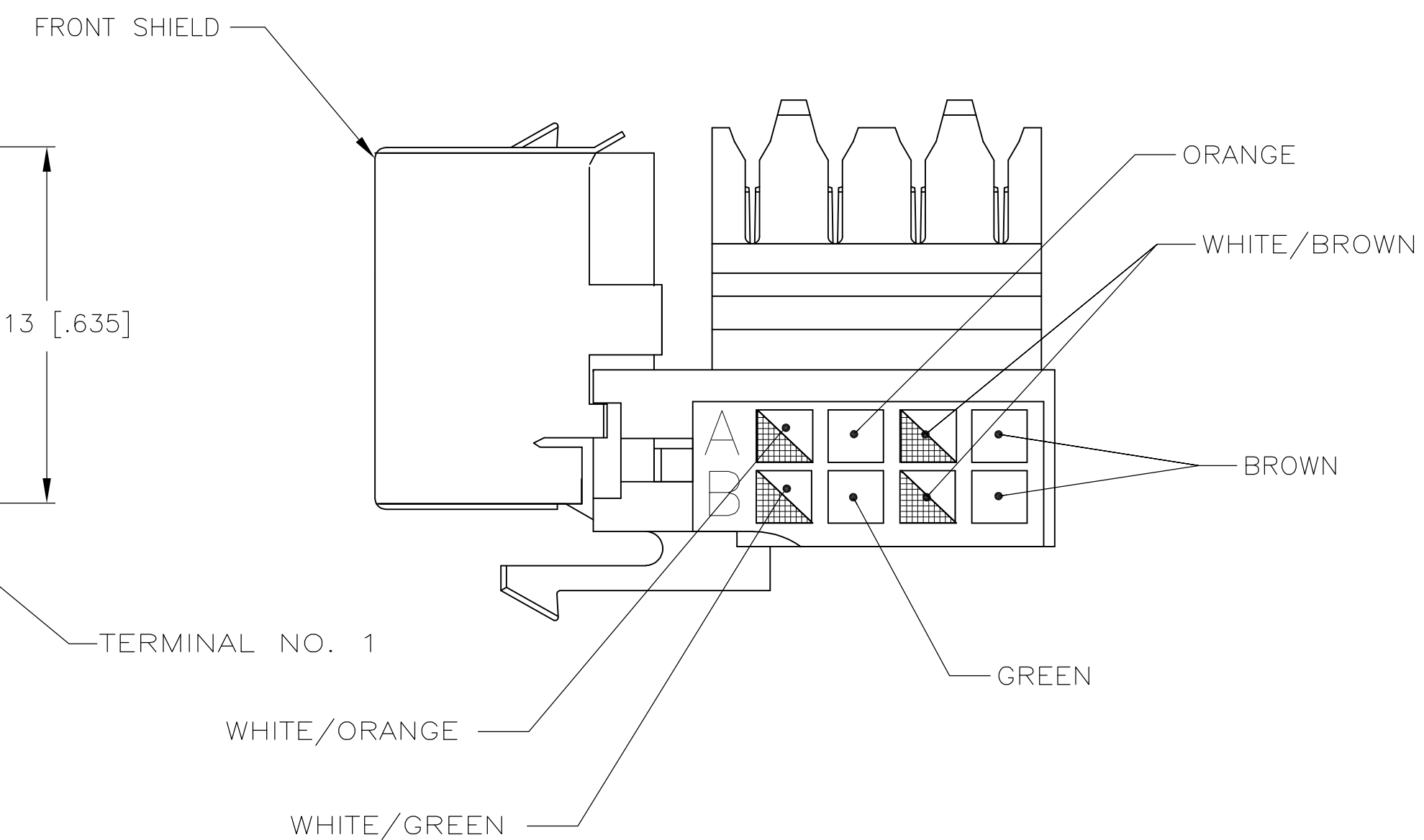
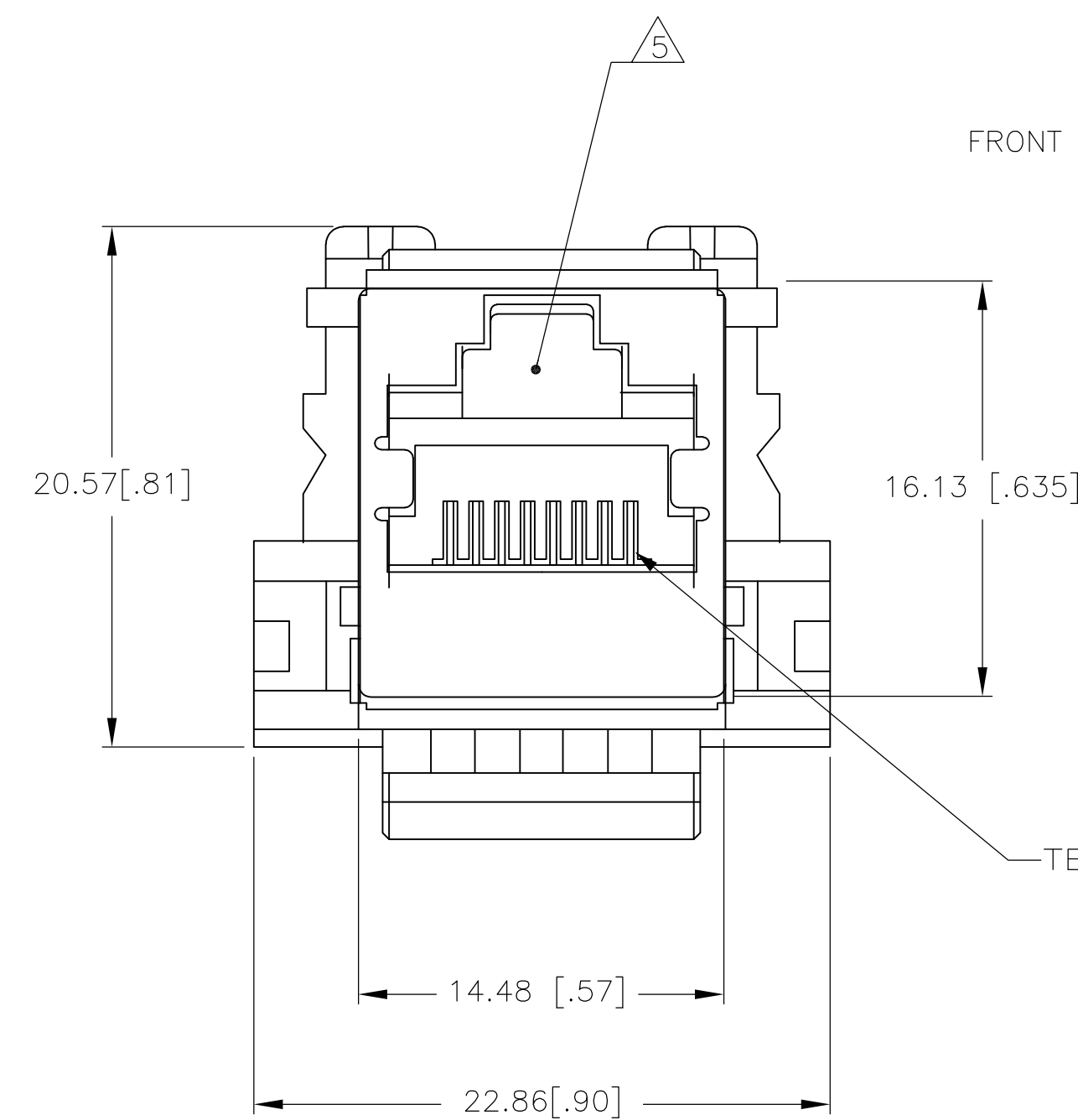
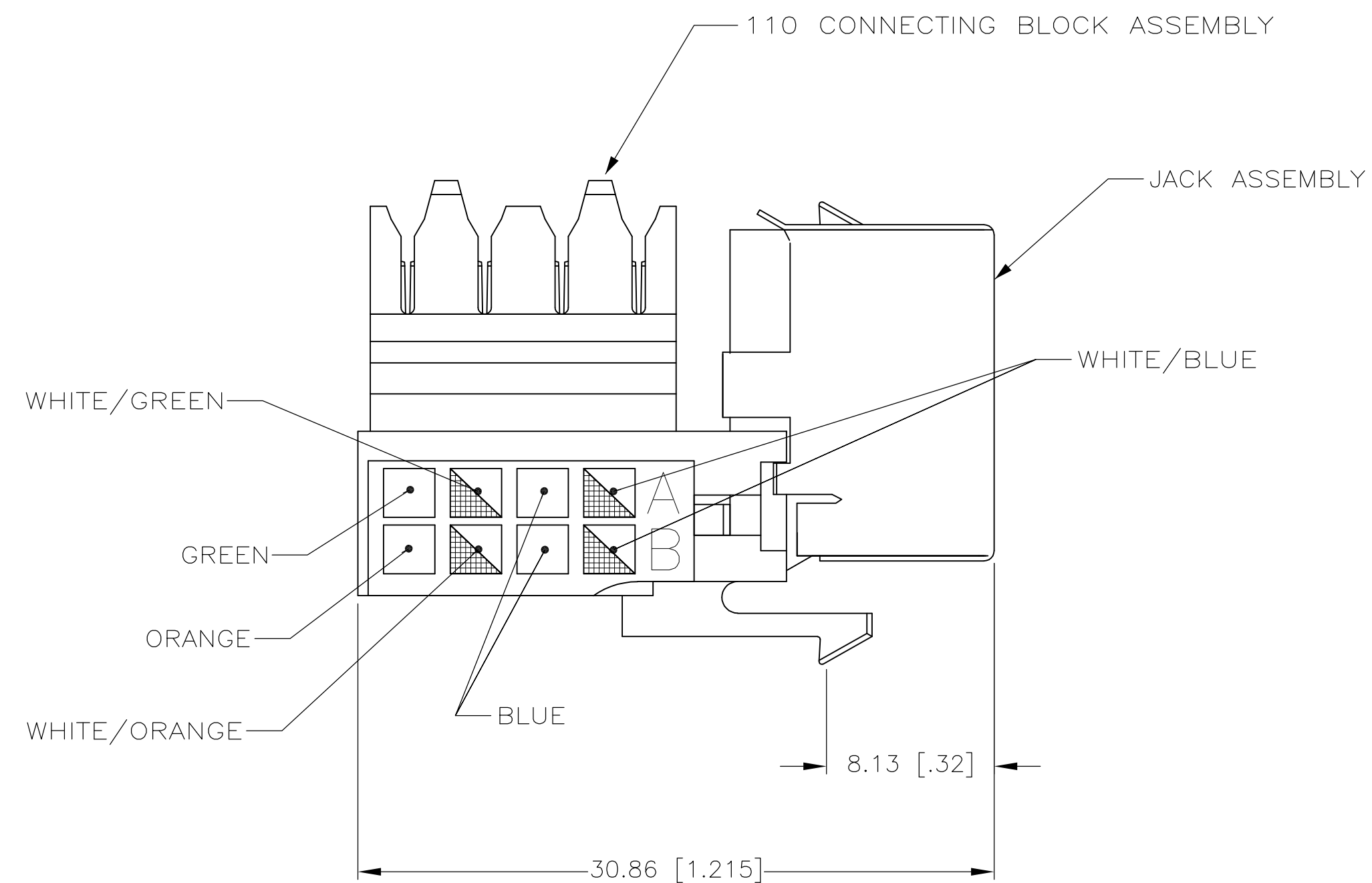
LOC	DIST	REVISIONS					
HM	00	P	LTR	DESCRIPTION	DATE	DWN	APP'D
			C1	REVISED PER ECO-11-005033	25MAR11	RK	HMR

ELECTRICAL SCHEMATIC
T568A

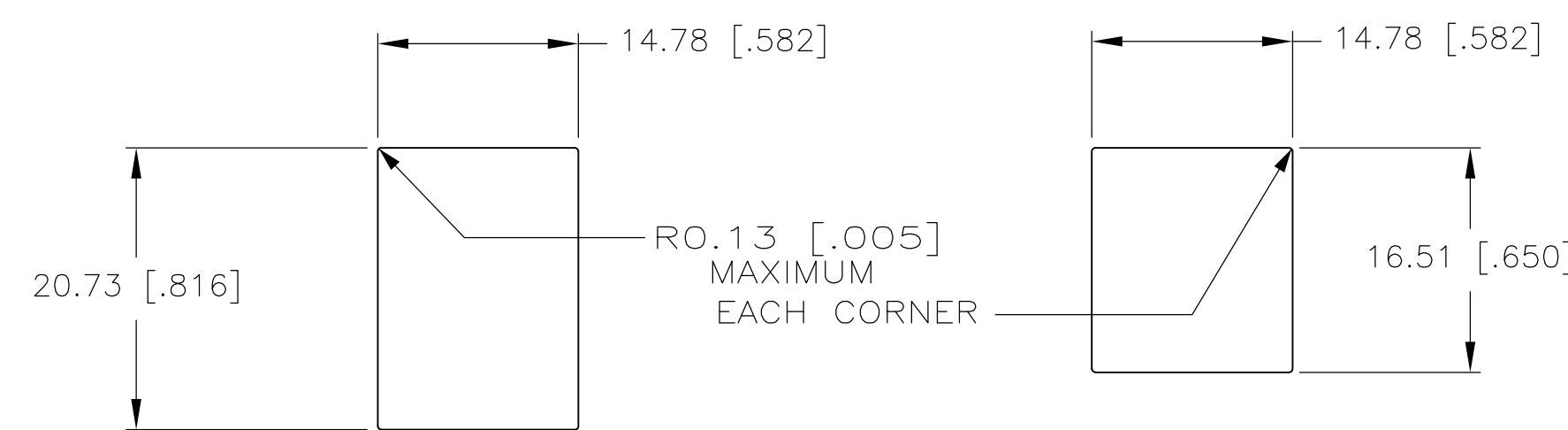
ELECTRICAL SCHEMATIC
T568B



- ① MATERIAL: HOUSING – POLYPHENYLENE OXIDE, 94V-0 RATED. BLACK.
- 110 BLOCKS – POLYCARBONATE, 94V-0 RATED.
- 110 CONTACTS – PHOSPHOROUS BRONZE, PLATED WITH $1.27\mu\text{m}$ [.000050] MINIMUM THICK GOLD IN LOCALIZED AREA AND $3.8\mu\text{m}$ [.000150] MINIMUM THICK MATTE TIN IN SOLDER AREA OVER $1.27\mu\text{m}$ [.000050] MINIMUM THICK NICKEL UNDERPLATE.
- SHIELDS– NICKEL PLATED BRASS.
2. 110 BLOCK WILL TERMINATE 22–26 AWG SOLID OR 7 STRAND CONDUCTORS, 1.27 [.050] MAXIMUM INSULATION DIAMETER.
3. MOUNTING PANEL THICKNESS $1.473 - 1.600$ [.058 – .063].
- 4 LEFT AND RIGHT SHIELDS SHIPPED NOT ASSEMBLED.
- ⑤ CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68 SUBPART F REQUIREMENTS.
- ⑥ THESE TWO SUGGESTED CUTOUT OPENINGS ARE USED IN TANDEM WITH DUAL FRONT AND BACK CUTOUTS.

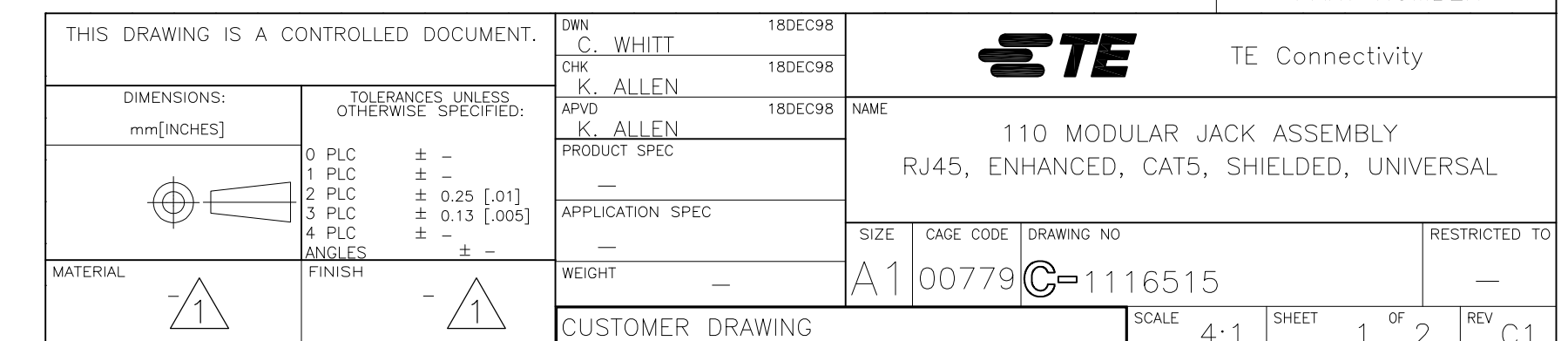


SUGGESTED SINGLE
PANEL CUTOUT
SCALE 2:1

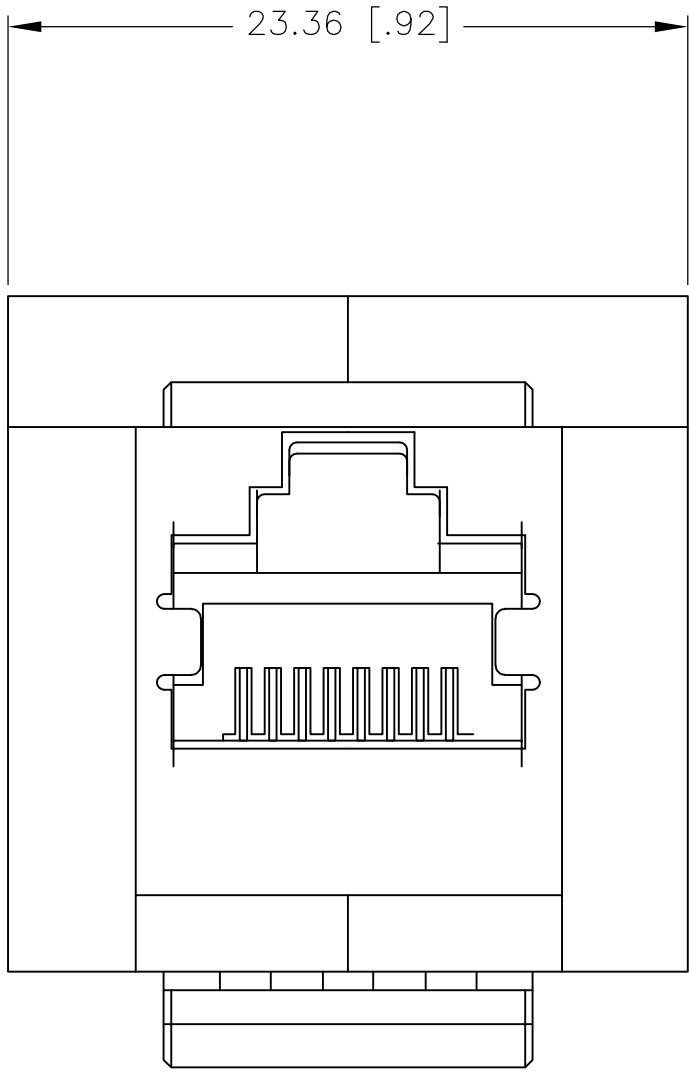
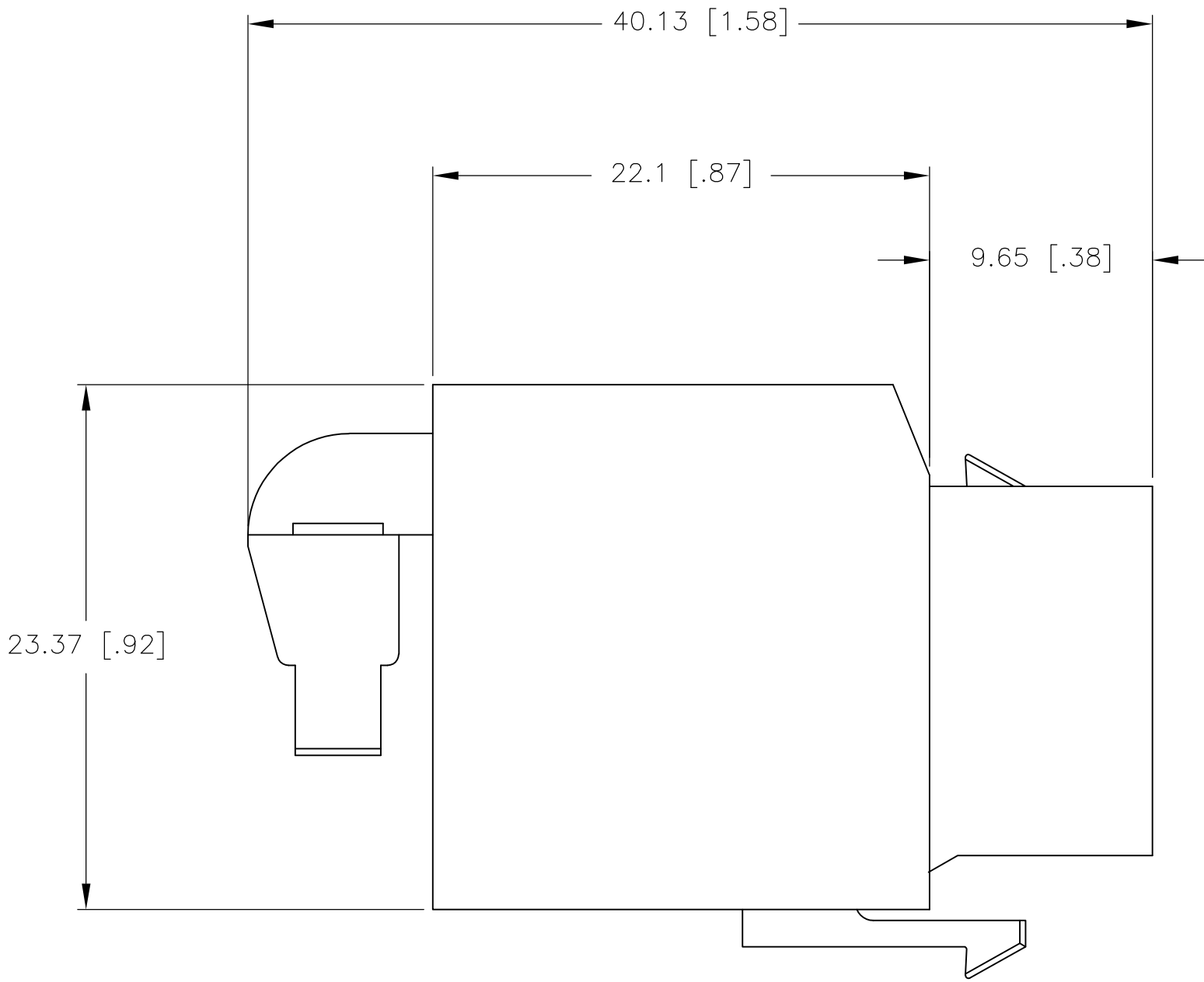


SUGGESTED BACK
PANEL CUTOUT
SCALE 2:1

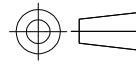
SUGGESTED FRONT
PANEL CUTOUT
SCALE 2:1



LOC		DIST		REVISIONS					
HM	00	P	LTR	DESCRIPTION			DATE	DWN	APVD
		—	—	— SEE SHEET 1 —			—	—	—



VIEW SHOWING SHIELDS ASSEMBLED

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN C. WHITT 18DEC98	 TE Connectivity	
DIMENSIONS: mm[INCHES]		CHK K. ALLEN 18DEC98		
	0 PLC	± —	APVD K. ALLEN 18DEC98	NAME
	1 PLC	± —	PRODUCT SPEC	
	2 PLC	± 0.25 [.01]	APPLICATION SPEC	
	3 PLC	± 0.13 [.005]		
MATERIAL	FINISH	—	SCALE	RESTRICTED TO
—		—	4:1	—
CUSTOMER DRAWING			SHEET 2 OF 2	REV C1